

# SH1123

# 256 X 64 16 Grayscale Dot Matrix OLED/PLED Driver with Controller

#### Preliminary

#### **Features**

- Support maximum 256 X 64 dot matrix panel with 16 grayscale
- Embedded 256 X 64 x 4bits SRAM
- Operating voltage:
  - I/O voltage supply: VDD1 = 1.65V 3.5V
  - Logic voltage supply: VDD2 = 2.4V 3.5V
  - DC-DC voltage supply: AVDD = 2.4V 3.5V
  - OLED Operating voltage supply: VPP = 7.0V 16.0V
- Maximum segment output current: 400μA
- Maximum common sink current: 102mA
- 8-bit 6800-series parallel interface, 8-bit 8080-series parallel interface, serial peripheral interface
- Programmable frame frequency and multiplexing ratio
- Row re-mapping and column re-mapping (ADC)

- Vertical scrolling
- On-chip oscillator
- Available internal DC-DC converter
- 256-step contrast control on monochrome passive OLED panel
- Low power consumption
  - Sleep mode: <5μA
- Wide range of operating temperatures: -40 to +85°C
- Available in COG and COF form

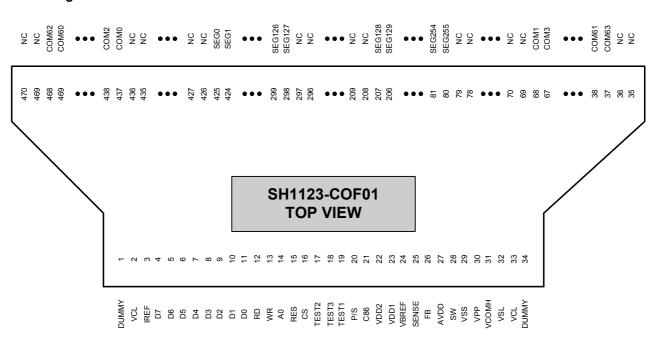
#### **General Description**

SH1123 is a single-chip CMOS OLED/PLED driver with controller for organic/polymer light emitting diode dot-matrix graphic display system. SH1123 consists of 256 segments, 64 commons with 16 grayscale that can support a maximum display resolution of 256 X 64. It is designed for Common Cathode type OLED panel.

SH1123 embeds with contrast control, display RAM oscillator and efficient DC-DC converter, which reduces the number of external components and power consumption. SH1123 is suitable for a wide range of compact portable applications, such as car audio, and calculator, etc.

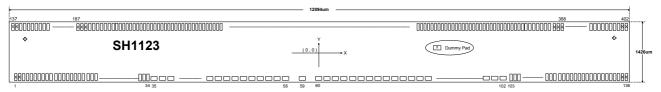


## **Pin Configuration**





## **Pad Configuration**





## **Block Diagram**

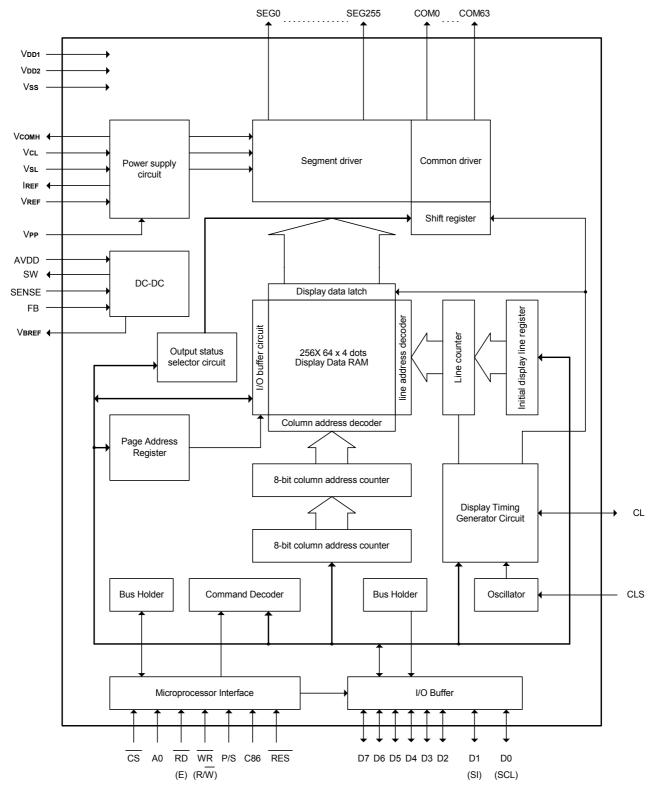


Figure 1 SH1123 block Diagram



## **Pad Description**

## **Power Supply**

Pad No.	Symbol	I/O	Description
70-72	VDD2	Supply	2.4 - 3.5V power supply input pad for logic.
68-69	VDD1	Supply	1.65 - 3.5V power supply input pad.
75,88	VDD1	Supply	1.65 - 3.5V power supply output for pad option.
60-63 AVDD Supply			2.4 - 3.5V power supply pad for the internal buffer of the DC-DC voltage converter.
53-58	Vss	Supply	Ground.
64,73,77,86,90,	Vss	Supply	Ground output for pad option.
46-49	VPP	Supply	This is the most positive voltage supply pad of the chip. It should be supplied externally.
38-40	VsL	Supply	This is a segment voltage reference pad. A capacitor should be connected between this pad and Vss.
35-37,100-102	VcL	Supply	This is a common voltage reference pad. This pad should be connected to Vss externally.

## **OLED Driver Supplies**

Pad No.	Symbol	I/O	Description
50	VREF	I	This is a voltage reference pad for pre-charge voltage in driving OLED device. Voltage should be set to match with the OLED driving voltage in current drive phase. It can either be supplied externally or by connecting to VPP.
99	İREF	0	This is a segment current reference pad. A resistor should be connected between this pad and Vss. Set the current at $10\mu A$ .
41-45	Vсомн	0	This is a pad for the voltage output high level for common signals. A capacitor should be connected between this pad and Vss.
59	SW	0	This is an output pad driving the gate of the external NMOS of the booster circuit.
65	FB	I	This is a feedback resistor input pad for the booster circuit. It is used to adjust the booster output voltage level, VPP.
66	SENSE	1	This is a source current pad of the external NMOS of the booster circuit.
67	VBREF	0	This is an internal voltage reference pad for booster circuit. A stabilization capacitor, typical $1\mu F$ , should be connected to Vss.



## **System Bus Connection Pads**

Pad No.	Symbol	I/O			Desc	cription							
81	CL	I/O	Left op		ock is output from	this pad. When in	abled, this pad should be ternal oscillator is disabled, rce.						
89	CLS	l	CLS = CLS = When	the internal clock of "H": Internal oscilla "L": Internal oscilla CLS = "L", an exte operation.	ator circuit is enab ator circuit is disab	led (requires exter	rnal input). d to the CL pad for						
74	C86	I	C86 =	This is the MPU interface switch pad. C86 = "H": 8080 series MPU interface. C86 = "L": 6800 series MPU interface.									
76	P/S	I	P/S = " P/S = " When I WR (F data re	H": Parallel data in L": Serial data inports of the P/S = "L", D2 to D7 R/W) are fixed to adding is not supports.	put. ut. 7 are HZ. D2 to D7 either "H" or "L". V orted. These are M	are HZ. D2 to D7 may be "H", "L" or Open ither "H" or "L". With serial data input, RAI ted. These are MPU interface input select selecting different interfaces:  8080-Parallel Interface  1 0							
82	<del>CS</del>	I		ad is the chip selectatade		= "L", then the ch	nip select becomes active,						
83	RES	I		a reset signal inpu	<u> </u>		settings are initialized. The						
84	A0	I	comma A0 = "H		to D7 are treated	l as display data.	ner the data bits are data or a and registers.						
85	$\overline{WR}$ $(R/\overline{W})$	I	When on the When of When	WR signal. The sigr	080 MPU, this is a nals on the data bus Series MPU: This	s are latched at the	ad connects to the 8080 rising edge of the WR signal. ntrol signal input terminal.						
87	RD (E)	I	When on the When the	gnal of the 8080 se his signal is "L".	080 series MPU, it eries MPU, and the 00 series MPU , th	e SH1123 data bu	his pad is connected to the s is in an output status  This is used as an enable						



# **System Bus Connection Pads (continued)**

Pad No.	Symbol	I/O	Description
91-98	D0 - D7 (SCL) (SI)	I/O I I	This is an 8-bit bi-directional data bus that connects to an 8-bit or 16-bit standard MPU data bus.  When the serial interface is selected, then D0 serves as the serial clock input pad (SCL) and D1 serves as the serial data input pad (SI). At this time, D2 to D7 are set to high impedance.  When the chip select is inactive, D0 to D7 are set to high impedance.

## **OLED Drive Pads**

Pad No.	Symbol	I/O	Description
3-34 103-134	COM0 - 63	0	These pads are Common signal output for OLED display.
139-186 190-365 369-400	SEG0 – 255	0	These pads are Segment signal output for OLED display.

## **Test Pads**

Pad No.	Symbol	I/O	Description
78	TEST1	I	Test pads, internal pull low, no connection for user.
80	TEST2	0	Test pads, no connection for user.
79	TEST3	I	Test pads, no connection for user.
1-2,135-138 187-189, 366-368 401-402	NC	-	NC pads, no connection for user.



#### **Functional Description**

## **Microprocessor Interface Selection**

The 8080-Parallel Interface, 6800-Parallel Interface or Serial Interface (SPI) can be selected by different selections of C86, P/S as shown in Table 1.

Table. 1

	6800-Parallel Interface	8080-Parallel Interface	Serial Interface
C86	0	1	0
P/S	1	1	0

#### 6800-series Parallel Interface

The parallel interface consists of 8 bi-directional data pads (D7-D0),  $\overline{WR}$  (R/ $\overline{W}$ ),  $\overline{RD}$  (E), A0 and  $\overline{CS}$ . When  $\overline{WR}$  (R/ $\overline{W}$ ) = "H", read operation from the display RAM or the status register occurs. When  $\overline{WR}$  (R/ $\overline{W}$ ) = "L", Write operation to display data RAM or internal command registers occurs, depending on the status of A0 input. The  $\overline{RD}$  (E) input serves as data latch signal (clock) when it is "H", provided that  $\overline{CS}$  = "L" as shown in Table. 2.

Table, 2

P/S	C86	Туре	cs	Α0	RD	$\overline{WR}$	D0 to D7
1	0	6800 microprocessor bus	CS	A0	E	$R/\overline{W}$	D0 to D7

In order to match the operating frequency of display RAM with that of the microprocessor, some pipeline processing are internally performed, which require the insertion of a dummy read before the first actual display data read. This is shown in Figure. 2 below.

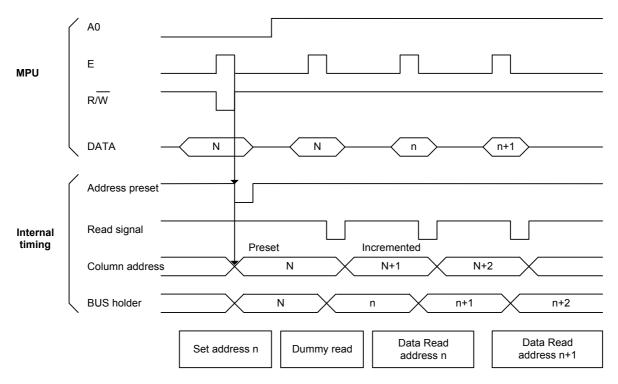


Figure. 2



## 8080-series Parallel Interface

The parallel interface consists of 8 bi-directional data pads (D7-D0),  $\overline{WR}$  (R/ $\overline{W}$ ),  $\overline{RD}$  (E), A0 and  $\overline{CS}$ . The  $\overline{RD}$  (E) input serves as data read latch signal (clock) when it is "L" provided that  $\overline{CS}$  = "L". Display data or status register read is controlled by A0 signal. The  $\overline{WR}$  (R/ $\overline{W}$ ) input serves as data write latch signal (clock) when it is "L" and provided that  $\overline{CS}$  = "L". Display data or command register write is controlled by A0 as shown in Table. 3.

Table. 3

P/S	C86	Туре	CS	Α0	RD	WR	D0 to D7
1	1	8080 microprocessor bus	CS	A0	RD	WR	D0 to D7

Similar to 6800-series interface, a dummy read is also required before the first actual display data read.

#### **Data Bus Signals**

The SH1123 identifies the data bus signal according to A0,  $\overline{RD}$  (E) and  $\overline{WR}$  (R/ $\overline{W}$ ) signals.

Table. 4

Common	6800 processor	8080 pr	ocessor	Function
Α0	(R/ <del>W</del> )	RD	WR	Function
1	1	0	1	Reads display data.
1	0	1	0	Writes display data.
0	1	0	1	Reads status.
0	0	1	0	Writes control data in internal register. (Command)



#### Serial Interface (SPI)

The serial interface consists of serial clock SCL, serial data SI, A0 and  $\overline{\text{CS}}$ . SI is shifted into an 8-bit shift register on every rising edge of SCL in the order of D7, D6, ... and D0. A0 is sampled on every eighth clock and the data byte in the shift register is written to the display data RAM or command register in the same clock. See Figure. 3.

Table. 5

P/S	C86	Туре	CS	A0	RD	WR	D0	D1	D2 to D7
0	0	Serial Interface (SPI)	cs	A0	-	-	SCL	SI	(HZ)

Note: "-" Must always be HIGH or LOW.

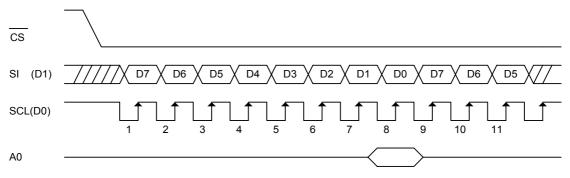


Figure. 3

- When the chip is not active, the shift registers and the counter are reset to their initial statuses.
- Read is not possible while in serial interface mode.
- Caution is required on the SCL signal when it comes to line-end reflections and external noise. We recommend the operation
  be rechecked on the actual equipment.

## Access to Display Data RAM and Internal Registers

This module determines whether the input data is interpreted as data or command. When A0 = ``H'', the inputs at D7 - D0 are interpreted as data and be written to display RAM. When A0 = ``L'', the inputs at D7 - D0 are interpreted as command, they will be decoded and be written to the corresponding command registers.



#### **Display Data RAM**

The Display Data RAM is a bit mapped static RAM holding the bit pattern to be displayed. The size of the RAM is 256 X 64 X 4 bits as shown in figure 3.

For mechanical flexibility, re-mapping on both segment and common outputs can be selected by software.

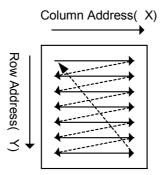
For vertical scrolling of the display, an internal register storing display start line can be set to control the portion of the RAM data to be mapped to the display.

Colu	ımn		CC	DL0			COL1			 COL254				COL255			
C	)	D7	D6	D5	D4	D3	D2	D1	D0	 D7	D6	D5	D4	D3	D2	D1	D0
1		D7	D6	D5	D4	D3	D2	D1	D0	 D7	D6	D5	D4	D3	D2	D1	D0
2	2	D7	D6	D5	D4	D3	D2	D1	D0	 D7	D6	D5	D4	D3	D2	D1	D0
	-																
62	2	D7	D6	D5	D4	D3	D2	D1	D0	 D7	D6	D5	D4	D3	D2	D1	D0
6	3	D7	D6	D5	D4	D3	D2	D1	D0	 D7	D6	D5	D4	D3	D2	D1	D0
ADC	=0		SE	.G0		SEG1			 SEG254				SEG255				
ADC	=1		SEG	3255			SEG	3254		 SEG1 SEG0					.G0		

Figure. 4

#### The Column/Row Address

As shown in **Figure. 3**, the display data RAM column address is specified by the Column and Row Address Set command. The specified column address is incremented (+1) with each display data read/ write command. When the Column address reachs the edge, it will be cleared and the row address will be incremented 1.



**RAM Address Increment Direction** 

Figure 5

Furthermore, as shown in Table 6, the Column re-mapping (ADC) command (segment driver direction select command) can be used to reverse the relationship between the display data RAM column address and the segment output. Because of this, the constraints on the IC layout when the OLED module is assembled can be minimized.

Table. 6

Segment Output	SEG0		SEG255
ADC "0"	0 (H) →	Column Address	→ FF (H)
ADC "1"	FF (H) <b>←</b>	Column Address	← 0 (H)



#### The Row Address Circuit

The Row address circuit specifies the Row address of display RAM and the Row address relating to the common output using the display start line set command, what is normally the top line of the display can be specified.

The screen scrolling function is active by changing display start line dynamically using the display start line set command.

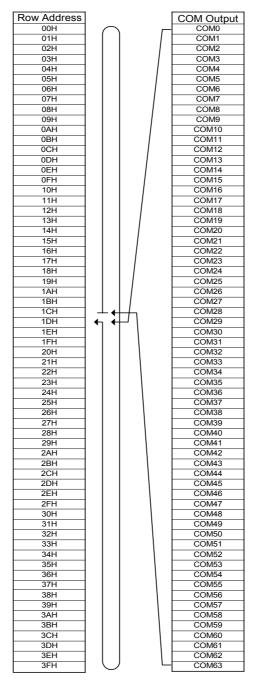


Figure 6 Display Start Line Setting function



#### **The Oscillator Circuit**

This is a RC type oscillator (Figure. 7) that produces the display clock. The oscillator circuit is only enabled when CLS = "H". When CLS = "L", the oscillation stops and the display clock is inputted through the CL terminal.

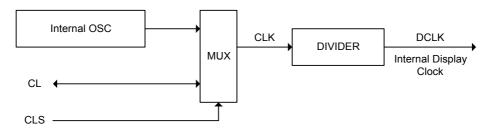


Figure. 7



#### **DC-DC Voltage Converter**

It is a switching voltage generator circuit, designed for hand held applications. In SH1123, built-in DC-DC voltage converter accompanied with an external application circuit (shown in Figure. 8) can generate a high voltage supply VPP from a low voltage supply input VDD. VPP is the voltage supply to the OLED driver block.

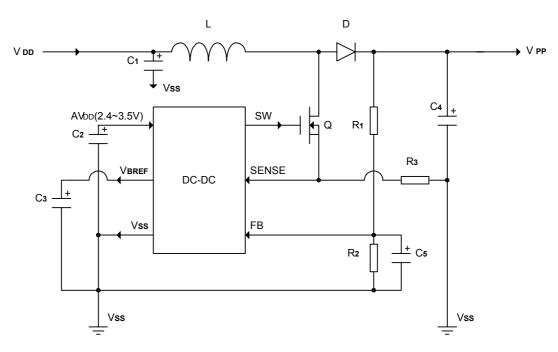


Figure. 8

$$VPP=(1+\frac{R1}{R2}) X VBREF, (R2: 80 - 120k\Omega)$$

#### **Current Control and Voltage Control**

This block is used to derive the incoming power sources into different levels of internal use voltage and current. VPP and VDD2 are external power supplies. VREF, a reference voltage, which is used to derive the driving voltage for segments and commons. IREF is a reference current source for segment current drivers.

#### **Common Drivers/Segment Drivers**

Segment drivers deliver 256 current sources to drive OLED panel. The driving current can be adjusted up to  $400\mu A$  with 256 steps. Common drivers generate voltage scanning pulses.

## 16 Grayscale

There are 16 level grayscale for segment driver. The grayscale table is as following.

RAM Data	Pulse Duty	Pulse width					
0000	0	0(DCLK)					
0001	1/15	4(DCLK)					
0010	2/15	8(DCLK)					
0011	3/15	12(DCLK)					
1110	14/15	56(DCLK)					
1111	15/15	60(DCLK)					



#### **Reset Circuit**

When the RES input falls to "L", these reenter their default state. The default settings are shown below:

- 1. Display is OFF. Common and segment are in high impedance state.
- 2. 256 X 64 Display mode
- 3. Normal segment and display data column address and row address mapping (SEG0 is mapped to column address 00H and COM0 mapped to row address 00H).
- 4. Shift register data clear in serial interface.
- 5. Display start line is set at display RAM Row address 00H.
- 6. Column address counter is set at 0.
- 7. Normal scanning direction of the common outputs.
- 8. Contrast control register is set at 80H.
- 9. Internal DC-DC is selected.



#### Commands

The SH1123 uses a combination of A0,  $\overline{RD}$  (E) and  $\overline{WR}$  (R/ $\overline{W}$ ) signals to identify data bus signals. As the chip analyzes and executes each command using internal timing clock only regardless of external clock, its processing speed is very high and its busy check is usually not required. The 8080 series microprocessor interface enters a read status when a low pulse is input to the  $\overline{RD}$  pad and a write status when a low pulse is input to the  $\overline{WR}$  pad. The 6800 series microprocessor interface enters a read status when a high pulse is input to the  $\overline{R/W}$  pad and a write status when a low pulse is input to this pad. When a high pulse is input to the E pad, the command is activated. (For timing, see AC Characteristics.). Accordingly, in the command explanation and command table,  $\overline{RD}$  (E) becomes 1(HIGH) when the 6800 series microprocessor interface reads status of display data. This is an only different point from the 8080 series microprocessor interface.

Taking the 8080 series, microprocessor interface as an example command will explain below.

When the serial interface is selected, input data starting from D7 in sequence.

#### **Command Set**

- 1. Set Lower Column Address of display RAM: (00H 0FH)
- 2. Set Higher Column Address of display RAM: (10H 17H)

Specifies column address of display RAM. Divide the column address into 3 higher bits and 4 lower bits. Set each of them into successions. When the microprocessor repeats to access to the display RAM, the column address counter is incremented during each access until address 128 is accessed. The row address is not changed during this time.

	A0	E RD	$R/\overline{W}$ $\overline{WR}$	D7	D6	D5	D4	D3	D2	D1	D0
Higher bits	0	1	0	0	0	0	1	0	A6	A5	A4
Lower bits	0	1	0	0	0	0	0	A3	A2	A1	A0

A6	A5	A4	А3	A2	A1	A0	Column address
0	0	0	0	0	0	0	0
0	0	0	0	0	0	1	1
			:				:
1	1	1	1	1	1	1	127

3~5. Blank



## 6. Set Display Start Line: (40H - 7FH)

Specifies Row address to determine the initial display line or COM0. The RAM display data becomes the top line of OLED screen. It is followed by the higher number of lines in ascending order, corresponding to the duty cycle. When this command changes the Row address, the smooth scrolling or page change takes place.

A0	E RD	$R/\overline{W}$ $\overline{WR}$	D7	D6	D5	D4	D3	D2	D1	D0
0	1	0	0	1	A5	A4	А3	A2	A1	A0

A5	A4	А3	A2	A1	A0	Row address
0	0	0	0	0	0	0
0	0	0	0	0	1	1
		:				:
1	1	1	1	1	0	62
1	1	1	1	1	1	63



#### 7. Set Contrast Control Register: (Double Bytes Command)

This command is to set contrast setting of the display. The chip has 256 contrast steps from 00 to FF. The segment output current increases as the contrast step value increases.

Segment output current setting: ISEG =  $\alpha/256$  X IREF X scale factor

Where:  $\alpha$  is contrast step; IREF is reference current equals 10µA; Scale factor = 40.

#### ■ The Contrast Control Mode Set: (81H)

When this command is input, the contrast data register set command becomes enabled. Once the contrast control mode has been set, no other command except for the contrast data register command can be used. Once the contrast data set command has been used to set data into the register, then the contrast control mode is released.

A0	E RD	R/W WR	D7	D6	D5	D4	D3	D2	D1	D0
0	1	0	1	0	0	0	0	0	0	1

#### ■ Contrast Data Register Set: (00H - FFH)

By using this command to set eight bits of data to the contrast data register, the OLED segment output assumes one of the 256 current levels.

When this command is input, the contrast control mode is released after the contrast data register has been set.

A0	E RD	$\frac{R}{WR}$	D7	D6	D5	D4	D3	D2	D1	D0	ISEG
0	1	0	0	0	0	0	0	0	0	0	Small
0	1	0	0	0	0	0	0	0	1	0	
0	1	0	0	0	0	0	0	0	1	1	
0	1	0					:				:
0	1	0	1	0	0	0	0	0	0	0	POR
0	1	0					:				:
0	1	0	1	1	1	1	1	1	1	0	
0	1	0	1	1	1	1	1	1	1	1	Large

#### 8. Set Segment Re-map: (A0H - A1H)

Change the relationship between RAM column address and segment driver. The order of segment driver output pads can be reversed by software. This allows flexible IC layout during OLED module assembly. For details, refer to the column address section of ADC. When display data is written or read, the column address is incremented by 1 as shown in Figure. 2.

	A0	E RD	$\frac{R}{W}$	D7	D6	D5	D4	D3	D2	D1	D0
l	0	1	0	1	0	1	0	0	0	0	ADC

When ADC = "L", the right rotates (normal direction). (POR)

When ADC = "H", the left rotates (reverse direction).

NOTE: The Set Segment Re-map command will change the address counter value, so it is recommended to set segment re-map in the initial program.

#### 9. Set Entire Display OFF/ON: (A4H - A5H)

Forcibly turns the entire display on regardless of the contents of the display data RAM. At this time, the contents of the display data RAM are held.

This command has priority over the normal/reverse display command.

A0	E RD	$R/\overline{W}$ $\overline{WR}$	D7	D6	D5	D4	D3	D2	D1	D0
0	1	0	1	0	1	0	0	1	0	D

When D = "L", the normal display status is provided. (POR)

When D = "H", the entire display ON status is provided.



#### 10. Set Normal/Reverse Display: (A6H -A7H)

Reverses the display ON/OFF status without rewriting the contents of the display data RAM.

	A0	E RD	R/W WR	D7	D6	D5	D4	D3	D2	D1	D0
j	0	1	0	1	0	1	0	0	1	1	D

When D = "L", the RAM data is high, being OLED ON potential (normal display). (POR)

When D = "H", the RAM data is low, being OLED ON potential (reverse display)

#### 11. Set Multiplex Ration: (Double Bytes Command)

This command switches default 64 multiplex modes to any multiplex ratio from 1 to 64. The output pads COM0-COM63 will be switched to corresponding common signal.

■ Multiplex Ration Mode Set: (A8H)

A0	E RD	R/W WR	D7	D6	D5	D4	D3	D2	D1	D0
0	1	0	1	0	1	0	1	0	0	0

#### ■ Multiplex Ration Data Set: (00H - 3FH)

A0	E RD	$\frac{R}{WR}$	D7	D6	D5	D4	D3	D2	D1	D0	Multiplex Ratio
0	1	0	*	*	0	0	0	0	0	0	1
0	1	0	*	*	0	0	0	0	1	0	2
0	1	0	*	*	0	0	0	0	1	1	3
0	1	0					:				:
0	1	0	*	*	1	1	1	1	1	0	63
0	1	0	*	*	1	1	1	1	1	1	64 (POR)

#### 12. DC-DC Setting: (Double Bytes Command)

This command is to control the DC-DC voltage converter status and the switch frequency. Issuing this command then display ON command will turn on the converter. The panel display must be off while issuing this command.

■ DC-DC Control Mode Set: (ADH)

A0	E RD	$\frac{R}{W}$	D7	D6	D5	D4	D3	D2	D1	D0
0	1	0	1	0	1	0	1	1	0	1

#### ■ DC-DC ON/OFF Mode Set:

A0	E RD	R/W WR	D7	D6	D5	D4	D3	D2	D1	D0
0	1	0	1	0	0	0	F2	F1	F0	D

When D = "L", DC-DC is disable.

When D = "H", DC-DC will be turned on when display on. (POR)

DC-DC STATUS	DISPLAY ON/OFF STATUS	Description
0	0	Sleep mode
0	1	External VPP must be used.
1	0	Sleep mode
1	1	Built-in DC-DC is used, Normal Display



F2	F1	F0	Switch Frequency
0	0	0	0.6SF kHz (POR)
0	0	1	0.7SF kHz
0	1	0	0.8SF kHz
0	1	1	0.9SF kHz
1	0	0	SF kHz
1	0	1	1.1SF kHz
1	1	0	1.2SF kHz
1	1	1	1.3SF kHz

SF=400kHZ  $\pm$  25%

13. Display OFF/ON: (AEH - AFH)

Alternatively turns the display on and off.

Α0	E RD	$R/\overline{W}$ $\overline{WR}$	D7	D6	D5	D4	D3	D2	D1	D0
0	1	0	1	0	1	0	1	1	1	D

When D = "L", Display OFF OLED. (POR)

When D = "H", Display ON OLED.

When the display OFF command is executed, power saver mode will be entered.

#### Sleep mode:

This mode stops every operation of the OLED display system, and can reduce current consumption nearly to a static current value if no access is made from the microprocessor. The internal status in the sleep mode is as follows:

- (1) Stops the oscillator circuit and DC-DC circuit.
- (2) Stops the OLED drive and outputs HZ as the segment/common driver output.
- (3) Holds the display data and operation mode provided before the start of the sleep mode.
- (4) The MPU can access to the built-in display RAM.
- 14. Set Row Address of Display RAM: (Double Bytes Command)

Specifies Row address to load display RAM data to Row address register. Any RAM data bit can be accessed when its Row address and column address are specified. The display remains unchanged even when the Row address is changed.

■ Row address Mode Setting: (B0H)

	A0	E RD	$R/\overline{W}$ $\overline{WR}$	D7	D6	D5	D4	D3	D2	D1	D0
Ī	0	1	0	1	0	1	1	0	0	0	0

■ Row address setting:

Ī	A0	E RD	$\frac{R}{W}$	D7	D6	D5	D4	D3	D2	D1	D0
Ī	0	1	0	*	*	A5	A4	А3	A2	A1	A0

A5	A4	A3	A2	A1	A0	Row address
0	0	0	0	0	0	0(POR)
0	0	0	0	0	1	1
0	0	0	0	1	0	2



0	0	0	0	1	1	3
1	1	1	1	0	1	3DH
1	1	1	1	1	0	3EH
1	1	1	1	1	1	3FH

#### 15. Set Common Output Scan Direction: (C0H - C8H)

This command sets the scan direction of the common output allowing layout flexibility in OLED module design. In addition, the display will have immediate effect once this command is issued. That is, if this command is sent during normal display, the graphic display will be vertically flipped.

A0	E RD	$\frac{R}{W}$	D7	D6	D5	D4	D3	D2	D1	D0
0	1	0	1	1	0	0	D	*	*	*

When D = "L", Scan from COM0 to COM [N -1]. (POR)

When D = "H", Scan from COM [N -1] to COM0.

#### 16. Set Display Offset: (Double Bytes Command)

This is a double byte command. The next command specifies the mapping of display start line to one of COM0-63 (it is assumed that COM0 is the display start line, that equals to 0). For example, to move the COM16 towards the COM0 direction for 16 lines, the 6-bit data in the second byte should be given by 010000. To move in the opposite direction by 16 lines, the 6-bit data should be given by (64-16), so the second byte should be 100000.

## ■ Display Offset Mode Set: (D3H)

A0	E RD	R/W WR	D7	D6	D5	D4	D3	D2	D1	D0
0	1	0	1	1	0	1	0	0	1	1

## ■ Display Offset Data Set: (00H~3FH)

A0	$\frac{E}{RD}$	$R/\overline{W}$ $\overline{WR}$	D7	D6	D5	D4	D3	D2	D1	D0	COMx
0	1	0	*	*	0	0	0	0	0	0	0 (POR)
0	1	0	*	*	0	0	0	0	1	0	1
0	1	0	*	*	0	0	0	0	1	1	2
0	1	0					:				:
0	1	0	*	*	1	1	1	1	1	0	62
0	1	0	*	*	1	1	1	1	1	1	63

Note: "\*" stands for "Don't care"



17. Set Display Clock Divide Ratio/Oscillator Frequency: (Double Bytes Command)

This command is used to set the frequency of the internal display clocks (DCLKs). It is defined as the divide ratio (Value from 1 to 16) used to divide the oscillator frequency. POR is 1. Frame frequency is determined by divide ratio, number of display clocks per row, MUX ratio and oscillator frequency.

■ Divide Ratio/Oscillator Frequency Mode Set: (D5H)

A0	$\frac{E}{RD}$	$\frac{R}{W}$	D7	D6	D5	D4	D3	D2	D1	D0
0	1	0	1	1	0	1	0	1	0	1

■ Divide Ratio/Oscillator Frequency Data Set: (00H - 3FH)

A0	E RD	$\frac{R}{W}$	D7	D6	D5	D4	D3	D2	D1	D0
0	1	0	A7	A6	A5	A4	Аз	A2	A1	Ao

A3 - A0 defines the divide ration of the display clocks (DCLK). Divide Ration = A[3:0]+1.

Аз	A2	A1	Ao	Divide Ration
0	0	0	0	1 (POR)
		:		:
1	1	1	1	16

A7 - A4 sets the oscillator frequency. Oscillator frequency increase with the value of A[7:4] and vice versa.

А7	A6	A5	A4	Oscillator Frequency of fosc
0	0	0	0	-25%
0	0	0	1	-20%
0	0	1	0	-15%
0	0	1	1	-10%
0	1	0	0	-5%
0	1	0	1	fosc (POR)
0	1	1	0	+5%
0	1	1	1	+10%
1	0	0	0	+15%
1	0	0	1	+20%
1	0	1	0	+25%
1	0	1	1	+30%
1	1	0	0	+35%
1	1	0	1	+40%
1	1	1	0	+45%
1	1	1	1	+50%



18. Set Discharge/Precharge Period: (Double Bytes Command)

This command is used to set the duration of the Precharge/Discharge period. The interval is counted in number of DCLK. POR is 2 DCLKs.

■ Precharge/Discharge Period Mode Set: (D9H)

A0	E RD	$\frac{R}{W}$	D7	D6	D5	D4	D3	D2	D1	D0
0	1	0	1	1	0	1	1	0	0	1

■ Precharge/Discharge Period Data Set: (00H - FFH)

A0	E RD	R/W WR	D7	D6	D5	D4	D3	D2	D1	D0
0	1	0	A7	A <sub>6</sub>	A5	A <sub>4</sub>	Аз	A <sub>2</sub>	A <sub>1</sub>	Ao

Precharge Period Adjust: (A3 - A0)

Аз	A2	A1	Ao	Pre-charge Period
0	0	0	0	INVALID
0	0	0	1	1 DCLKs
0	0	1	0	2 DCLKs (POR)
		:		:
1	1	1	0	14 DCLKs
1	1	1	1	15 DCLKs

Discharge Period Adjust: (A7 - A4)

A7	A6	A5	A4	Dis-charge Period
0	0	0	0	INVALID
0	0	0	1	1 DCLKs
0	0	1	0	2 DCLKs (POR)
		:		:
1	1	1	0	14 DCLKs
1	1	1	1	15 DCLKs

19. Set Common pads hardware configuration: (Double Bytes Command)

This command is to set the common signals pad configuration (sequential or alternative) to match the OLED panel hardware layout.

■ Common Pads Hardware Configuration Mode Set: (DAH)

A0	$\frac{E}{RD}$	$\frac{R}{WR}$	D7	D6	D5	D4	D3	D2	D1	D0	
0	1	0	1	1	0	1	1	0	1	0	

■ Sequential/Alternative Mode Set: (02H - 12H)

A0	E RD	R/W WR	D7	D6	D5	D4	D3	D2	D1	D0
0	1	0	0	0	0	D	0	0	1	0

When D = "L", Sequential.

COM31, 30 - 1, 0	SEG0, 1 - 130, 131	COM32, 33 - 62, 63
	,	

When D = "H", Alternative. (POR)

COM62, 60 - 2, 0	SEG0, 1 - 130, 131	COM1, 3 - 61, 63



## 20. Set VCOM Deselect Level: (Double Bytes Command)

This command is to set the common pad output voltage level at deselect stage.

■ VCOM Deselect Level Mode Set: (DBH)

A0	E RD	R/W WR	D7	D6	D5	D4	D3	D2	D1	D0
0	1	0	1	1	0	1	1	0	1	1

■ VCOM Deselect Level Data Set: (00H - FFH)

	A0	E RD	$\frac{R}{W}$	D7	D6	D5	D4	D3	D2	D1	D0
I	0	1	0	A7	A6	A5	A4	Аз	A2	A1	Ao

 $V_{\text{COMH}} = \beta X V_{\text{REF}} = (0.430 + A[7:0] X 0.006415) X V_{\text{REF}}$ 

A[7:0]	β	A[7:0]	β
00H	0.430	20H	
01H		21H	
02H		22H	
03H		23H	
04H		24H	
05H		25H	
06H		26H	
07H		27H	
08H		28H	
09H		29H	
0AH		2AH	
0BH		2BH	
0CH		2CH	
0DH		2DH	
0EH		2EH	
0FH		2FH	
10H		30H	
11H		31H	
12H		32H	
13H		33H	
14H		34H	
15H		35H	0.770 (POR)
16H		36H	
17H		37H	
18H		38H	
19H		39H	
1AH		3AH	
1BH		3BH	
1CH		3CH	
1DH		3DH	
1EH		3EH	
1FH		3FH	
40H - FFH	1		



## 21. Set Discharge VSL Level (30H - 3FH):

This command is to set the Segment output discharge voltage level.

A0	E RD	$\frac{R}{W}$	D7	D6	D5	D4	D3	D2	D1	D0
0	1	0	0	0	1	1	D3	D2	D1	D <b>o</b>

This command is to set the segment discharge voltage level

D[3:0]	VsL
00H	0V(Default)
01H	0.1VREF
02H	0.125 VREF
03H	0.150 VREF
04H	0.175 V <b>REF</b>
05H	0.2 VREF
06H	0.225 VREF
07H	0.250 VREF
08H	0.275 VREF
09H	0.3 VREF
0AH	0.325 VREF
0BH	0.350 VREF
0CH	0.375 VREF
0DH	0.4 VREF
0EH	0.425 V <b>REF</b>
0FH	0.450 VREF

## 22. Read-Modify-Write: (E0H)

A pair of Read-Modify-Write and End commands must always be used. Once read-modify-write is issued, column address is not incremental by read display data command but incremental by write display data command only. It continues until End command is issued. When the End is issued, column address returns to the address when read-modify-write is issued. This can reduce the microprocessor load when data of a specific display area is repeatedly changed during cursor blinking or others.

A0	E RD	$\frac{R}{W}$	D7	D6	D5	D4	D3	D2	D1	D0
0	1	0	1	1	1	0	0	0	0	0

Cursor display sequence:



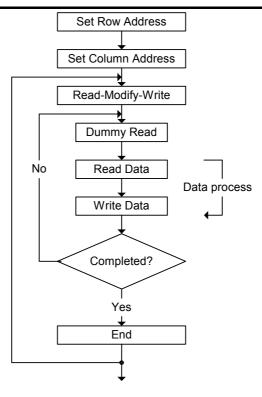


Figure. 9

## 23. End: (EEH)

Cancels Read-Modify-Write mode and returns column address to the original address (when Read-Modify-Write is issued.)

A0	E RD	$\frac{R}{W}$	D7	D6	D5	D4	D3	D2	D1	D0
0	1	0	1	1	1	0	1	1	1	0

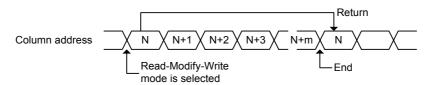


Figure. 10



#### 24. NOP: (E3H)

Non-Operation Command.

A0	E RD	$\frac{R}{W}$	D7	D6	D5	D4	D3	D2	D1	D0
0	1	0	1	1	1	0	0	0	1	1

#### 25. Write Display Data

Write 8-bit data in display RAM. As the column address is incremental by 1 automatically after each write, the microprocessor can continue to write data of multiple words.

A0	E RD	$\frac{R}{W}$	D7	D6	D5	D4	D3	D2	D1	D0
1	1	0			V	/rite R	AM da	ta		

#### 26. Read Status

AC	)	E RD	$\frac{R}{W}$	D7	D6	D5	D4	D3	D2	D1	D0
0		0	1	BUSY	ON/OFF	*	*	*	0	0	0

BUSY: When high, the SH1123 is busy due to internal operation or reset. Any command is rejected until BUSY goes low. The busy check is not required if enough time is provided for each cycle.

ON/OFF: Indicates whether the display is on or off. When goes low the display turns on. When goes high, the display turns off. This is the opposite of Display ON/OFF command.

#### 27. Read Display Data

Reads 8-bit data from display RAM area specified by column address and Row address. As the column address is increment by 1 automatically after each writing, the microprocessor can continue to read data of multiple words. A single dummy read is required immediately after column address being setup. Refer to the display RAM section of FUNCTIONAL DESCRIPTION for details. Note that no display data can be read via the serial interface.

A0	E RD	$\frac{R}{W}$	D7	D6	D5	D4	D3	D2	D1	D0
1	0	1			R	ead R	AM da	ta		



## **Command Table**

0						Code						Formation	
Command	Α0	RD	$\overline{WR}$	D7	D6	D5	D4	D3	D2	D1	D0	Function	
Set Column Address     4 lower bits	0	1	0	0	0	0	0	Lowe	er colu	mn ad	dress	Sets 4 lower bits of column address of display RAM in register. (POR = 00H)	
Set Column     Address 3 higher     bits	0	1	0	0	0	0	1	0		ner col addres		Sets 3 higher bits of column address of display RAM in register. (POR = 10H)	
Reserved     Command	0	1	0	0	0	1	0	0	1	0	0	Reserved	
4. Reserved Command	0	1	0	0	0	1	0	0	1	1	0	Reserved	
5. Reserved Command	0	1	0	0	0	1	0	1	1	1	D	Reserved	
6. Set Display Start Line	0	1	0	0	1		Sta	art Line	e addre	ess		Specifies RAM display line for COM0. (POR = 40H)	
7. The Contrast Control Mode Set	0	1	0	1	0	0	0	0	0	0	1	This command is to set Contrast Setting of the display.	
Contrast Data Register Set	0	1	0			(	Contra	st Data	a			The chip has 256 contrast steps from 00 to FF. (POR = 80H)	
8. Set Segment Re-map (ADC)	0	1	0	1	0	1	0	0	0	0	ADC	The right (0) or left (1) rotation. (POR = A0H)	
9. Set Entire Display OFF/ON	0	1	0	1	0	1	0	0	1	0	D	Selects normal display (0) or Entire Display ON (1). (POR = A4H)	
10. Set Normal/ Reverse Display	0	1	0	1	0	1	0	0	1	1	D	Normal indication (0) when low, but reverse indication (1) when high. (POR = A6H)	
11. Multiplex Ration Mode Set	0	1	0	1	0	1	0	1	0	0	0	This command switches default 63 multiplex mode to	
Multiplex Ration Data Set	0	1	0	*	*		Ŋ	/lultiple	ex Rati	0		any multiplex ratio from 1 to 64. (POR = 3FH)	
12. DC-DC Control Mode Set	0	1	0	1	0	1	0	1	1	0	1	This command is to control the DC-DC voltage and the switch	
DC-DC ON/OFF Mode Set	0	1	0	1	0	0	0	F2	F1	F0	D	frequency. (POR = 81H)	



# **Command Table (Continued)**

Commond						Code						Function
Command	Α0	RD	$\overline{WR}$	D7	D6	D5	D4	D3	D2	D1	D0	- Function
13. Display OFF/ON	0	1	0	1	0	1	0	1	1	1	D	Turns on OLED panel (1) or turns off (0). (POR = AEH)
14 Day Address Cat	0	1	0	1	0	1	1	0	0	0	0	Specifies Row address to
14. Row Address Set Row Address	0	1	0	*	*			Row A	ddress	5		load display RAM data to Row address register. (POR = 00H)
15. Set Common Output Scan Direction	0	1	0	1	1	0	0	D	*	*	*	Scan from COM0 to COM [N - 1] (0) or Scan from COM [N -1] to COM0 (1). (POR = C0H)
16. Display Offset Mode Set	0	1	0	1	1	0	1	0	0	1	1	This is a double byte command that specifies the
Display Offset Data Set	0	1	0	*	*			CC	Мх			mapping of display start line to one of COM0-63. (POR = 00H)
17. Set Display Divide Ratio/Oscillator Frequency Mode Set	0	1	0	1	1	0	1	0	1	0	1	This command is used to set the frequency of the internal display clocks. (POR = 50H)
Divide Ratio/Oscillator Frequency Data Set	0	1	0	Osc	illator	Freque	ency		Divide	Ratio		, ,
18. Dis-charge / Pre-charge Period Mode Set	0	1	0	1	1	0	1	1	0	0	1	This command is used to set the duration of the dis-charge and pre-charge
Dis-charge /Pre-charge Period Data Set	0	1	0	Di	s-charç	ge Peri	iod	Pr	e-char	ge Per	iod	period. (POR = 22H)
19. Common Pads Hardware Configuration Mode Set	0	1	0	1	1	0	1	1	0	1	0	This command is to set the common signals pad configuration. (POR = 12H)
Sequential/Alternat ive Mode Set	0	1	0	0	0	0	D	0	0	1	0	
20. VCOM Deselect Level Mode Set	0	1	0	1	1	0	1	1	0	1	1	This command is to set the common pad output voltage
VCOM Deselect Level Data Set	0	1	0			VC	COM (	3 X VR	EF)			level at deselect stage. (POR = 35H)
21. Discharge voltage VSL level setting	0	1	0	0	0	1	1	D3	D2	D1	D0	Set the discharge voltage level.
22. Read-Modify-Write	0	1	0	1	1	1	0	0	0	0	0	Read-Modify-Write start.
23. End	0	1	0	1	1	1	0	1	1	1	0	Read-Modify-Write end.
24. NOP	0	1	0	1	1	1	0	0	0	1	1	Non-Operation Command
25. Write Display Data	1	1	0			٧	/rite R	AM da	ta	•	•	
26. Read Status	0	0	1	BUSY	ON/ OFF	*	*	*	0	0	0	
27. Read Display Data	1	0	1			R	ead R	AM da	ta			

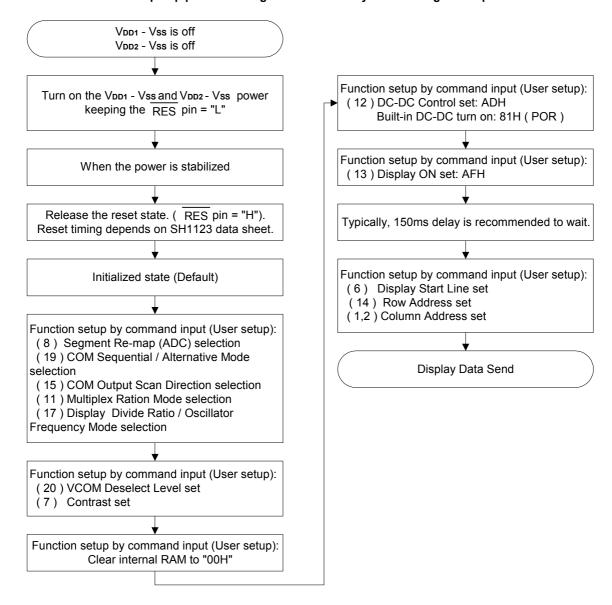
 $\textbf{Note:} \ \mathsf{Do} \ \mathsf{not} \ \mathsf{use} \ \mathsf{any} \ \mathsf{others} \ \mathsf{command}, \ \mathsf{or} \ \mathsf{the} \ \mathsf{system} \ \mathsf{malfunction} \ \mathsf{may} \ \mathsf{result}.$ 



## **Command Description**

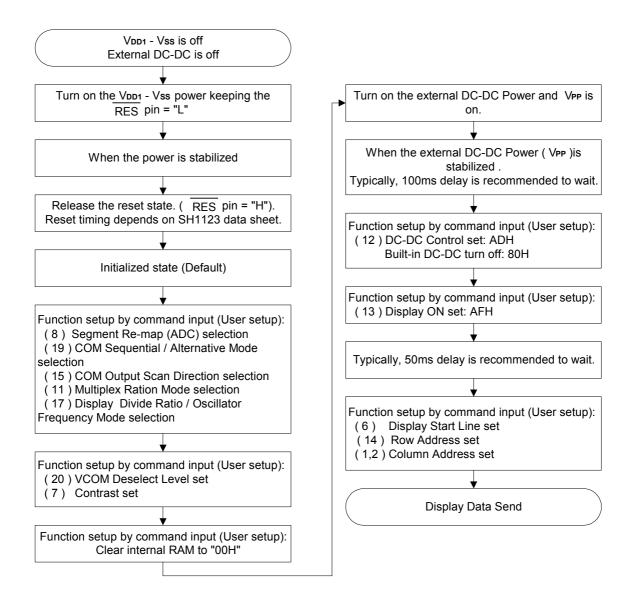
#### Instruction Setup: Reference

- 1. Power On and Initialization
- 1.1. When the built-in DC-DC pump power is being used immediately after turning on the power:



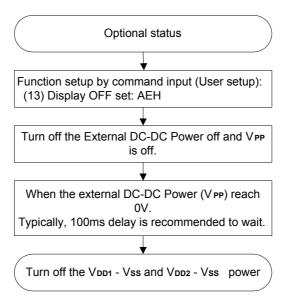


#### 1.2. When the external DC-DC pump power is being used immediately after turning on the power:





#### 2. Power Off





## **Absolute Maximum Rating\***

DC Supply Voltage (VDD1, VDD2)0.3V to +3.6V
DC Supply Voltage (VPP)0.3V to +18V
Input Voltage0.3V to V <b>DD1</b> + 0.3V
Operating Ambient Temperature40°C to +85°C
Storage Temperature55°C to +125°C

#### \*Comments

Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to this device. These are stress ratings only. Functional operation of this device under these or any other conditions above those indicated in the operational sections of this specification is not implied or intended. Exposure to the absolute maximum rating conditions for extended periods may affect device reliability.

## **Electrical Characteristics**

DC Characteristics (Vss = 0V, VDD1 = 1.65 - 3.5V, VDD2 = 2.4 - 3.5V, TA =+25°C, unless otherwise specified)

Symbol	Parameter	Min.	Тур.	Max.	Unit	Condition
VDD1	Power supply of I/O	1.65	1	3.5	٧	
VDD2	Power supply of logic device	2.4	-	3.5	V	
V₽₽	OLED Operating voltage	7.0	-	16.0	V	
VBREF	Internal voltage reference	1.20	1.26	1.32	V	With one 1μF capacitor
lDD1	Dynamic current Consumption 1	-	110	160	μΑ	VDD1 = 3V, VDD2 = 3V, IREF = $10\mu$ A, Contrast $\alpha$ = 256, Bulid-in DC-DC OFF, Display ON, display data = All ON, No panel attached.
lDD2	Dynamic current Consumption 2	-	190	285	μΑ	VDD1 = 3V, VDD2 = 3V, VPP = 12V, IREF = -10 $\mu$ A, Contrast $\alpha$ = 256, Bulid-in DC-DC ON, Display ON, Display data = All ON, No panel attached.
PP	OLED dynamic current consumption	-	550	825	μΑ	VDD1 = 3V, VDD2 = 3V, VPP = 12V, IREF = -10 $\mu$ A, Contrast $\alpha$ = 256, Display ON, Display data = All ON, No panel attached.
ISP	Sleep mode current Consumption in VDD1 & VDD2	-	0.01	5	μΑ	During sleep, TA = +25°C, VDD1 = 3V, VDD2 = 3V.
137	Sleep mode current Consumption in VPP	-	0.01	5	μΑ	During sleep, TA = +25°C, VPP = 12V.
		-388	-400	-412	μА	VDD1 = 3V, VDD2 = 3V, VPP = 12V, IREF = -12.5μA, RLOAD = $20k\Omega$ , Display ON. Contrast $\alpha$ = 256.
ISEG	Segment output current	-	-275	-	μА	VDD1 = 3V, VDD2 = 3V, VPP = 12V, IREF = -12.5 $\mu$ A, RLOAD = 20 $k\Omega$ ,Display ON. Contrast $\alpha$ = 176.
1323	Segment output current	-	-150	-	μА	VDD1 = 3V, VDD2 = 3V, VPP = 12V, IREF = -12.5 $\mu$ A, RLOAD = 20 $k\Omega$ , Display ON. Contrast $\alpha$ = 96.
		-	-25	-	μА	VDD1 = 3V, VDD2 = 3V, VPP = 12V, IREF = -12.5 $\mu$ A, RLOAD = 20 $k\Omega$ , Display ON. Contrast $\alpha$ = 16.
∆lSEG1	Segment output current uniformity	-	-	±3	%	$\Delta$ ISEG1 = (ISEG - IMID)/IMID X 100% IMID = (IMAX + IMIN)/2 ISEG [0:255] at contrast $\alpha$ = 256.
∆lSEG2	Adjacent segment output Current uniformity	-	-	±2	%	$\triangle$ ISEG2 = (ISEG [N] - ISEG [N+1])/(ISEG [N] + ISEG [N+1]) X 100% ISEG [0:255] at contrast $\alpha$ = 256.



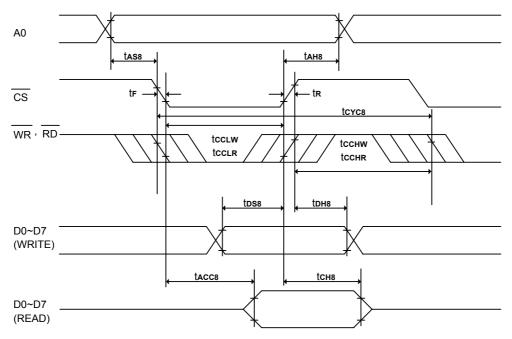
# **DC Characteristics (Continued)**

Symbol	Parameter	Min.	Тур.	Max.	Unit	Condition
VIHC	High-level input voltage	0.8 X VDD1	ı	VDD1	V	A0, D0 - D7, $\overline{RD}$ (E), $\overline{WR}$ (R/ $\overline{W}$ ), $\overline{CS}$ , CLS,
VILC	Low-level input voltage	Vss	-	0.2 X VDD1	V	CL, C86, P/S and RES .
Vонс	High-level output voltage	0.8 X V <b>DD1</b>	ı	VDD1	٧	Iон = -0.5mA (D0 - D7, and CL).
Volc	Low -level output voltage	Vss	ı	0.2 X V <b>DD1</b>	>	IoL = 0.5mA (D0 - D7, and CL).
Iц	Input leakage current	-1.0	1	1.0	μΑ	$\frac{\text{Vin} = \text{VDD1 or Vss (A0, } \overline{\text{RD}} \text{ (E), } \overline{\text{WR}} \text{ (R/W),}}{\overline{\text{CS}}, \text{ CLS, C86, P/S and } \overline{\text{RES}} \text{ ).}}$
lHZ	HZ leakage current	-1.0	ı	1.0	μΑ	When the D0 - D7, and CL are in high impedance.
fosc	Oscillation frequency	380	426	470	KHz	TA = +25°C.
fFRM	Frame frequency for 64 Commons	-	104	-	Hz	When fosc = 426kHz, Divide ratio = 1, common width = 64 DCLKs.
Rpre	Precharge switch resistance	-	300	450	Ω	VPP=12V, VSEG= 0.770 x VPP - 0.4V
Rdis	Discharge switch resistance	-	8	10	Ω	VPP=12V, VSL= 0.4V
Ron1	Common switch resistance	-	10	12	Ω	VPP=12V, VCOM= Vss+0.4V
Ron2	Common switch resistance	-	350	-	Ω	VPP=12V, Vcom= 0.770 x VPP - 0.4V



## **AC Characteristics**

## (1) System buses Read/Write characteristics 1 (For the 8080 Series Interface MPU)

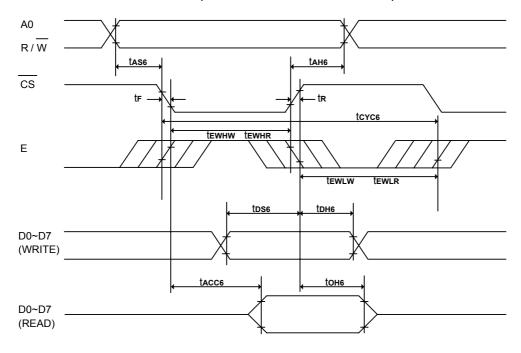


 $(V_{DD1} = 1.65 - 3.5V, V_{DD2} = 2.4 - 3.5V, T_{A} = +25^{\circ}C)$ 

Symbol	Parameter	Min.	Тур.	Max.	Unit	Condition
tcyc8	System cycle time	300	-	-	ns	
tAS8	Address setup time	0	-	-	ns	
tAH8	Address hold time	0	-	-	ns	
tDS8	Data setup time	40	-	-	ns	
tDH8	Data hold time	15	-	-	ns	
tсн8	Output disable time	10	-	70	ns	CL=100pF
tACC8	RD access time	-	-	140	ns	CL=100pF
tccLw	Control L pulse width (WR)	100	-	-	ns	
tcclr	Control L pulse width (RD)	120	-	-	ns	
tccнw	Control H pulse width (WR)	100	-	-	ns	
tcchr	Control H pulse width (RD)	100	-	-	ns	
tr	Rise time	-	-	15	ns	
tF	Fall time	-	-	15	ns	



## (2) System buses Read/Write Characteristics 2 (For the 6800 Series Interface MPU)

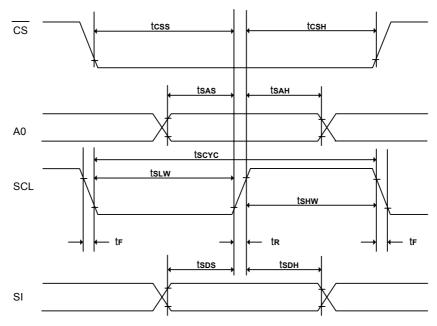


 $(V_{DD1} = 1.65 - 3.5V, V_{DD2} = 2.4 - 3.5V, T_{A} = +25^{\circ}C)$ 

Symbol	Parameter	Min.	Тур.	Max.	Unit	Condition
tcyc6	System cycle time	300	-	-	ns	
tAS6	Address setup time	0	-	-	ns	
tAH6	Address hold time	0	-	-	ns	
tDS6	Data setup time	40	-	-	ns	
tDH6	Data hold time	15	-	-	ns	
tOH6	Output disable time	10	-	70	ns	CL=100pF
tACC6	Access time	-	-	140	ns	CL=100pF
tewnw	Enable H pulse width (Write)	100	-	-	ns	
tewhr	Enable H pulse width (Read)	120	-	-	ns	
tEWLW	Enable L pulse width (Write)	100	-	-	ns	
tEWLR	Enable L pulse width (Read)	100	-	-	ns	_
tr	Rise time	-	-	15	ns	
tF	Fall time	-	-	15	ns	



## (3) System buses Write characteristics 3(For the Serial Interface MPU)

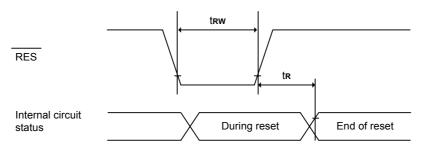


 $(V_{DD1} = 1.65 - 3.5V, V_{DD2} = 2.4 - 3.5V, T_{A} = +25^{\circ}C)$ 

Symbol	Parameter	Min.	Тур.	Max.	Unit	Condition
Тѕсүс	Serial clock cycle	250	-	-	ns	
Tsas	Address setup time	150	-	-	ns	
Тѕан	Address hold time	150	-	-	ns	
Tsds	Data setup time	100	-	-	ns	
Тѕон	Data hold time	100	-	-	ns	
Tcss	CS setup time	120	-	ı	ns	
Тсѕн	CS hold time time	60	-	ı	ns	
Тѕнѡ	Serial clock H pulse width	100	-	ı	ns	
TsLw	Serial clock L pulse width	100	-	-	ns	
tr	Rise time	-	-	15	ns	
tF	Fall time	-	-	15	ns	



## (4) Reset Timing



(VDD1 = 1.65 - 3.5V, VDD2 = 2.4 - 3.5V, TA = +25°C)

Symbol	Parameter	Min.	Тур.	Max.	Unit	Condition
tR	Reset time	-	-	1.0	μS	
trw	Reset low pulse width	5.0	ı	-	μS	



## **Application Circuit (for reference only)**

## **Reference Connection to MPU:**

1. 8080 series interface: (Internal oscillator, External VPP)

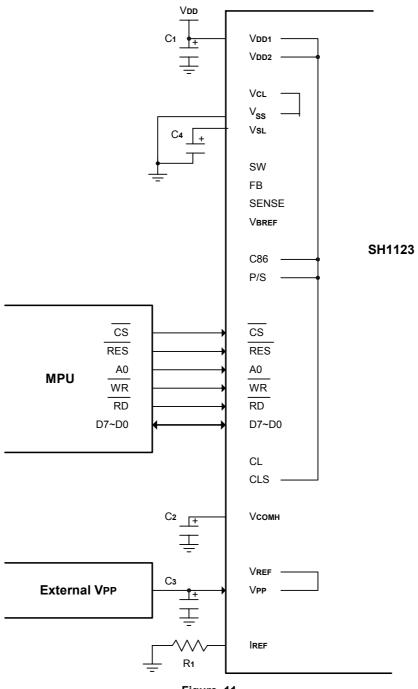


Figure. 11

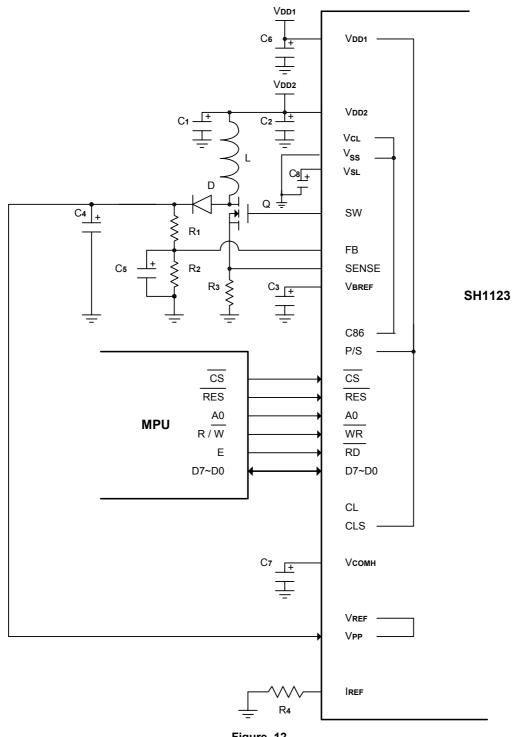
## Note:

 $C1 - C4: 4.7 \mu F.$ 

R1: about 910k $\Omega$ , R1 = (Voltage at IREF - Vss)/IREF



## 2. 6800 Series Interface: (Internal oscillator, Built-in DC-DC)



## Figure. 12

#### Note:

L, D, Q, R1, R2, R3, C1 - C6: Please refer to following description of DC-DC module.

C6, C7,C8: 4.7µF

R3: about  $910k\Omega$ , R4 = (Voltage at IREF - Vss)/IREF



## 3. Serial Interface: (External oscillator, External VPP)

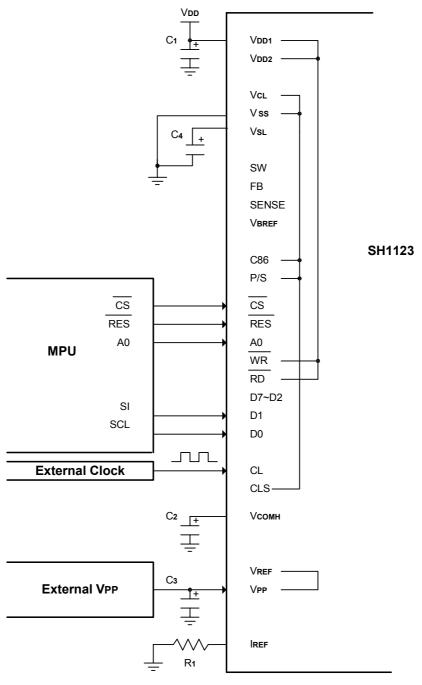


Figure. 13

## Note:

C1 - C4: 4.7µF

R1: about  $910k\Omega$ , R1 = (Voltage at IREF - Vss)/IREF



## DC-DC:

Below application circuit is an example for the input voltage of 3V V DD2 to generate V PP of about 12V @ 10mA-25mA application.

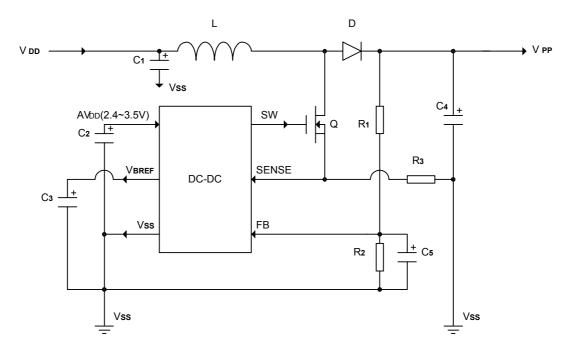
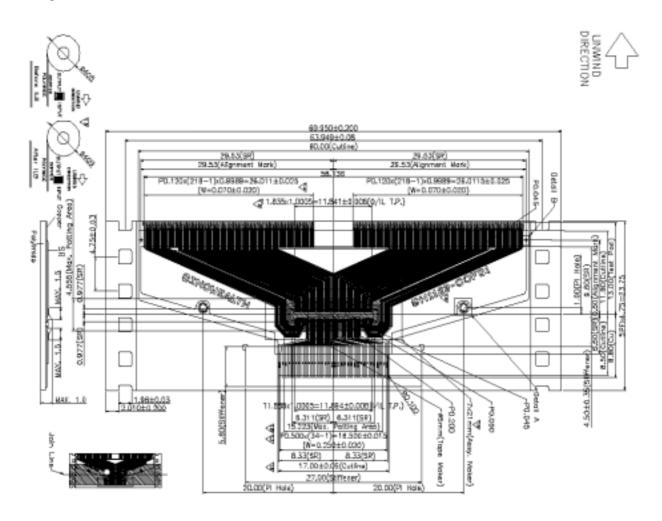


Figure. 14

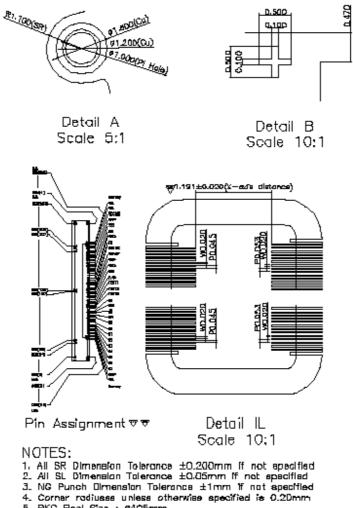
Symbol	Value	Recommendation
L	10μΗ	LQH3C100K24
D	SCHOTTKY DIODE	20V@0.5A, MBR0520
Q	MOSFET	N-FET with low R <b>DS(ON)</b> and low V <b>тн</b> , MGSF1N02LT1
R1	930kΩ	1%, 1/8W
R <sub>2</sub>	110kΩ	1%, 1/8W
R3	0.12Ω	1%, 1/2W
C1	1 - 10μF	Low ESR/6.3V
C2	0.1 - 1μF	Ceramic/16V
Сз	1μF	Ceramic/16V
C4	6.8μF	Low ESR/16V
C5	1000pF	Ceramic/16V



## **Package Information**







- 5. PKC Reel Size : #405mm 6. Input IL total pitch from top 2nd to bottom 2nd 7. Output IL total pitch from top 2nd to bottom 2nd 8. Min Pitch=45um=IL Pitch

#### **Cautions Concerning Storage:**

- 1. When storing the product, it is recommended that it be left in its shipping package. After the seal of the packing bag has been broken, store the products in a nitrogen atmosphere.
- 2. Storage conditions:

Storage State	Storage Conditions
unopened (less than 90 days)	Temperature: 5 to 30°C; humidity: 80%RH or less.
After seal of broken (less than 30 days)	Room temperature, dry nitrogen atmosphere

- 3. Don't store in a location exposed to corrosive gas or excessive dust.
- 4. Don't store in a location exposed to direct sunlight of subject to sharp changes in temperature.
- 5. Don't store the product such that it subjected to an excessive load weight, such as by stacking.
- 6. Deterioration of the plating may occur after long-term storage, so special care is required. It is recommended that the products be inspected before use.



# Ordering Information

Part No.	Package
SH1123-COF01	COF Form



# **Data Sheet Revision History**

Version	Content	Date
0.0	Original	Dec. 2005
0.1	<ol> <li>VDC=2.4~3.5V (Page 1,5,33);</li> <li>RON1=10Ω(Typ), RON1=12Ω(Max) (Page 34);</li> <li>Add pad Configuration (Page 3)</li> <li>Add a capacitor between VSL and VSS (Page 5,39,40,41)</li> </ol>	Jan.2006
0.2	<ol> <li>A V<sub>DD</sub>: 2.4 - 3.5V power supply pad for the internal buffer of the DC-DC voltage converter. (Page 1,4,5,14,33)</li> <li>Add the note for Set Segment Re-map command: The Set Segment Re-map command would change the address counter value, so it is recommended to set segment re-map in the initial program. (Pare 18)</li> <li>Change the description of DC-DC switch frequency control setting by the DC-DC setting command. (Page 20)</li> </ol>	Jun.2006
0.3	<ol> <li>Add Pin Configuration (Page 2)</li> <li>Change the Power On and Initialization flowchart. (Page 30-31)</li> <li>Add Package Information. (Page 45-46)</li> <li>Add Order Information. (Page 47)</li> </ol>	Nov. 2007
	<ol> <li>Change "set higher column address of display RAM(10H-1FH)" to(10H-17H). (Page 16)</li> <li>Change Command table set column address 4 higher bits to 3 higher bits.(Page 28)</li> <li>Change Figure 13 (Page 41)</li> <li>Change Precharge switch resistance DC Characteristics test condition.(Page 34)</li> </ol>	Dec. 2007

With collaboration of https://www.displayfuture.com